

Truth Table

LED	Vo
ON	LOW
OFF	HIGH

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$, unless otherwise specified. Typical Values at $T_A = 25^{\circ}C$)

INPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	$V_{\rm F}$	$I_F = 10 \text{mA}$		1.15	1.5	V
Reverse Current	I_R	$V_R = 5V$			10	μΑ
Terminal Capacitance	C_{IN}	V = 0V, $f = 1MHz$		33		pF

OUTPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Operating Voltage	V_{CC}		3		15	V
Supply Current	$I_{\text{CC(off)}}$	$V_{CC} = 5V$, $I_F = 0mA$		1.6	5	mA
High Level Output Current	І _{ОН}	$I_F = 0 \text{mA}, V_{CC} = V_O = 15 \text{V}$			100	μΑ



ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$, unless otherwise specified, Typical Values at $T_A = 25^{\circ}C$)

COUPLED

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Supply Current	I _{CC(on)}	$V_{CC} = 5V, I_F = 10mA$		1.6	5	mA
Low Level Output Voltage	V _{OL}	$V_{CC} = 5V$, $I_F = I_{F(on)}$ (max), $R_L = 270\Omega$			0.4	V
Turn-On Threshold Current	$I_{F(on)}$	$V_{CC} = 5V, R_L = 270\Omega$			1.6	mA
Turn-Off Threshold Current	$I_{F(off)}$	$V_{CC} = 5V, R_L = 270\Omega$		1		mA
Hysteresis Rtio	I _{F(off)} /I _{F(on)}	$V_{CC} = 5V, R_L = 270\Omega$	0.5		0.9	
Turn-On Time	t _(on)	$V_{CC} = 5V$, $I_F = I_{F(on)} (max)$,			4	μs
Fall Time	t_{f}	$R_L = 270\Omega$		0.1		
Turn-Off Time	$t_{(off)}$				4	
Rise Time	t _r			0.1		

ISOLATION

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Isolation Voltage	$V_{\rm ISO}$	R.H. = 40% to 60%, t = 1 min, Note 1	5000			V_{RMS}
Input - Output Resistance	R _{I-O}	$V_{I-O} = 500 VDC$ R.H. = 40% to 60%	10 ¹¹			Ω

Note 1: Measured with input leads shorted together and output leads shorted together.



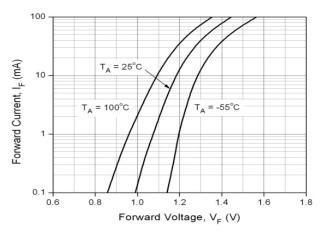


Fig 1 Forward Current vs Forward Voltage

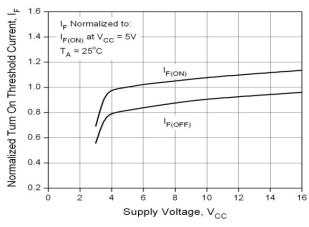


Fig 3 Normalized Turn-On Current vs Supply Voltage

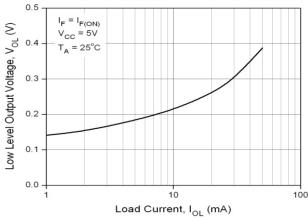


Fig 5 Low Level Output Voltage vs Load Current

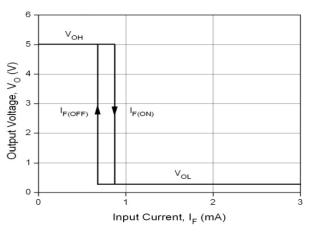


Fig 2 Transfer Characteristics

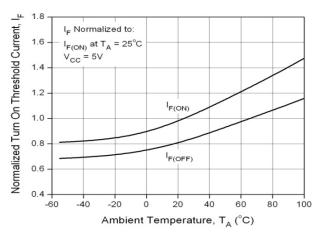


Fig 4 Normalized Turn-On Current vs Ambient temperature

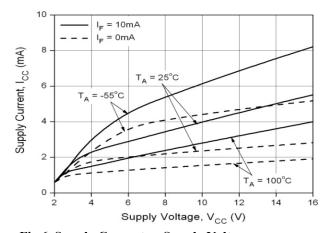
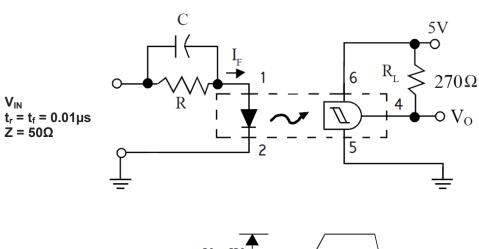
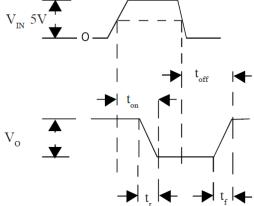


Fig 6 Supply Current vs Supply Voltage







Switching Time Test Circuit and Waveform



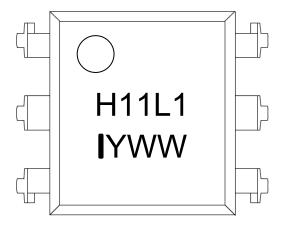
ORDER INFORMATION

H11L1 (UL Approval)				
After PN	PN	Description	Packing quantity	
None	H11L1	Standard DIP6	65 pcs per tube	
G	H11L1G	10mm Lead Spacing	65 pcs per tube	
SM	H11L1SM	Surface Mount	65 pcs per tube	
SMT&R	H11L1SMT&R	Surface Mount Tape & Reel	1000 pcs per reel	

H11L1V (UL Approval and VDE Approvals)					
After PN	PN	Description	Packing quantity		
None	H11L1V	Standard DIP6	65 pcs per tube		
G	H11L1VG	10mm Lead Spacing	65 pcs per tube		
SM	H11L1VSM	Surface Mount	65 pcs per tube		
SMT&R	H11L1VSMT&R	Surface Mount Tape & Reel	1000 pcs per reel		



DEVICE MARKING



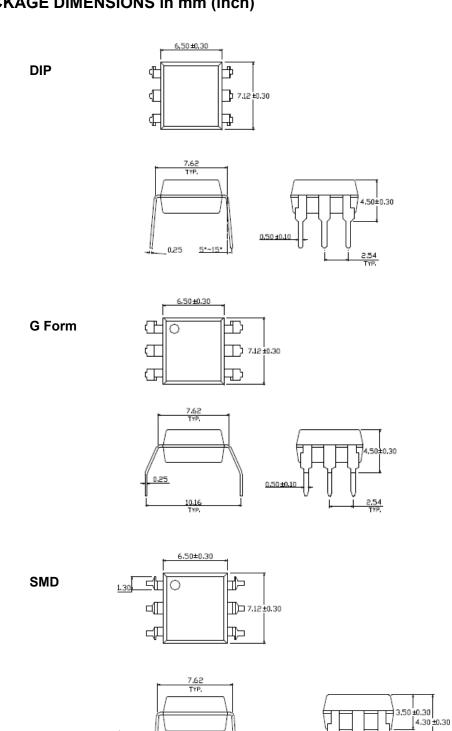
H11L1 denotes Device Part Number (H11L1 as example)

I denotes Isocom

Y denotes 1 digit Year code WW denotes 2 digit Week code



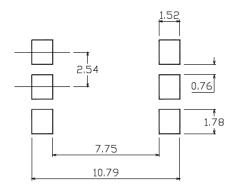
PACKAGE DIMENSIONS in mm (inch)



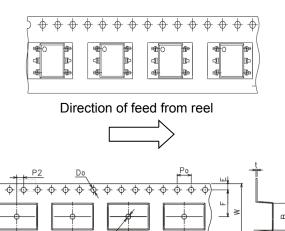
0.6MIN

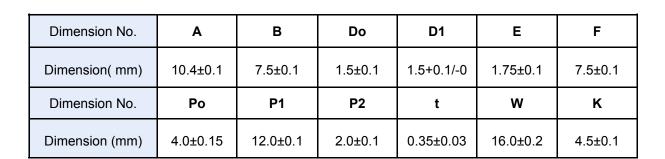


RECOMMENDED PAD LAYPUT FOR SMD (mm)



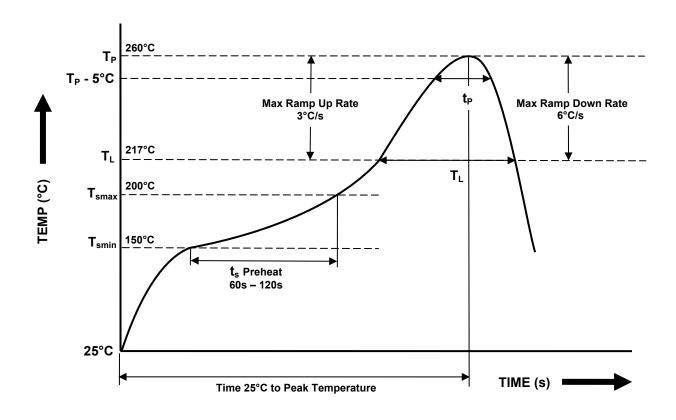
TAPE AND REEL PACKAGING



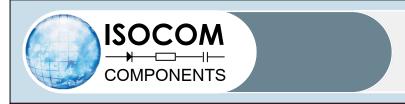




IR REFLOW SOLDERING TEMPERATURE PROFILE (One Time Reflow Soldering is Recommended)

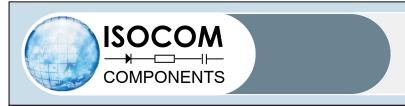


Profile Details	Conditions
Preheat - Min Temperature (T _{SMIN}) - Max Temperature (T _{SMAX}) - Time T _{SMIN} to T _{SMAX} (t _s)	150°C 200°C 60s - 120s
$\begin{tabular}{lll} \textbf{Soldering Zone} \\ - & \begin{tabular}{l} - $	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T _{smax} to T _P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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- Do not immerse device body in solder paste.



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